AUTOMOTIVE GRADE

RoHS

COMPLIANT

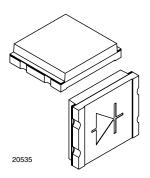
GREEN

(5-2008)**



Vishay Semiconductors

Silicon PIN Photodiode



DESCRIPTION

TEMD5080X01 is a PIN photodiode with enhanced blue sensitivity. The miniature surface mount package (SMD) include a chip with 7.7 mm² sensitive area, covered by clear epoxy.

FEATURES

- Package type: surface mount
- · Package form: top view
- Dimensions (L x W x H in mm): 5 x 4.24 x 1.12
- Radiant sensitive area (in mm2): 7.7
- AEC-Q101 qualified
- Enhanced blue photo sensitivity: S (400 nm) rel > 30 %
- Peak sensitivity at 940 nm
- Suitable for visible and near infrared radiation
- Low junction capacitance
- Fast response times
- Angle of half sensitivity: $\varphi = \pm 65^{\circ}$
- Floor life: 72 h, MSL 4, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

Note

** Please see document "Vishay Material Category Policy": www.vishay.com/doc?99902

APPLICATIONS

· High speed photo detector

| PRODUCT SUMMARY | | | | |
|-----------------|----------------------|---------|-------------|--|
| COMPONENT | I _{ra} (μΑ) | φ (deg) | λ0.1 (nm) | |
| TEMD5080X01 | 60 | ± 65 | 350 to 1100 | |

Note

· Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION | | | | |
|----------------------|---------------|------------------------------|--------------|--|
| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM | |
| TEMD5080X01 | Tape and reel | MOQ: 1500 pcs, 1500 pcs/reel | Top view | |

Note

• MOQ: minimum order quantity

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | |
|---|-----------------------------------|-------------------|---------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Reverse voltage | | V _R | 25 | V |
| Power dissipation | T _{amb} ≤ 25 °C | P _V | 215 | mW |
| Junction temperature | | Tj | 100 | °C |
| Operating temperature range | | T _{amb} | - 40 to + 100 | °C |
| Storage temperature range | | T _{stg} | - 40 to + 110 | °C |
| Soldering temperature | Acc. reflow solder profile fig. 8 | T _{sd} | 260 | °C |
| Thermal resistance junction/ambient | | R _{thJA} | 350 | K/W |

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|--|--|-------------------|------|-------------------------|------|-------|
| Forward voltage | I _F = 50 mA | V _F | | 1 | 1.3 | V |
| Breakdown voltage | I _R = 100 μA, E = 0 | V _(BR) | 25 | | | V |
| Reverse dark current | V _R = 10 V, E = 0 | I _{ro} | | 2 | 10 | nA |
| Diode capacitance | V _R = 0 V, f = 1 MHz, E = 0 | C _D | | 90 | | pF |
| | V _R = 3 V, f = 1 MHz, E = 0 | C _D | | 30 | 40 | pF |
| Open circuit voltage | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | Vo | | 350 | | mV |
| Temperature coefficient of Vo | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | TK _{Vo} | | - 2.6 | | mV/K |
| Short circuit current | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | I _k | | 50 | | μA |
| Temperature coefficient of I _k | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$ | TK _{Ik} | | 0.1 | | %/K |
| Reverse light current | $E_{e}=1~\text{mW/cm}^{2},\lambda=400~\text{nm},\\ V_{R}=5~\text{V}$ | I _{ra} | | 18 | | μΑ |
| | $E_V = 100 \text{ Ix, CIE illuminant A,}$ $V_R = 5 \text{ V}$ | I _{ra} | | 8.5 | | μΑ |
| | E_e = 1 mW/cm ² , λ = 950 nm, V_R = 5 V | I _{ra} | | 60 | | μΑ |
| — | CIE illuminant A | TK _{lra} | | 0.15 | | %/K |
| Temperature coefficient of I _{ra} | $\lambda = 950 \text{ nm}$ | TK _{lra} | | 0.1 | | %/K |
| Angle of half sensitivity | | φ | | ± 65 | | deg |
| Wavelength of peak sensitivity | | λ_{p} | | 940 | | nm |
| Range of spectral bandwidth | | λ _{0.1} | | 350 to 1100 | | nm |
| Noise equivalent power | V _R = 10 V, λ = 400 nm | NEP | | 1.1 x 10 ⁻¹³ | | W/√Hz |
| Rise time | $V_R = 5 \text{ V}, R_L = 50 \Omega,$ $\lambda = 850 \text{ nm}$ | t _r | | 40 | | ns |
| Fall time | $V_R = 5 \text{ V}, R_L = 50 \Omega,$ $\lambda = 850 \text{ nm}$ | t _f | | 40 | | ns |

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

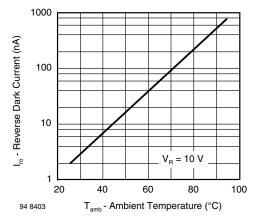


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

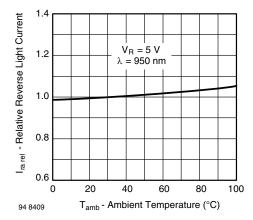


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

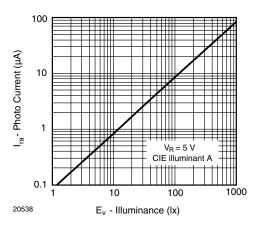


Fig. 3 - Reverse Light Current vs. Irradiance

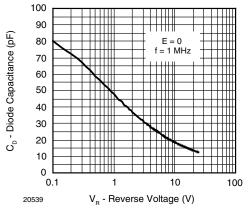


Fig. 4 - Diode Capacitance vs. Reverse Voltage

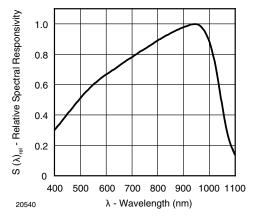


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

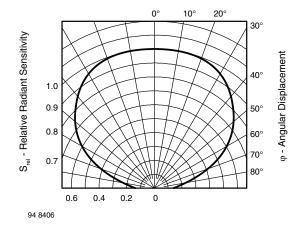
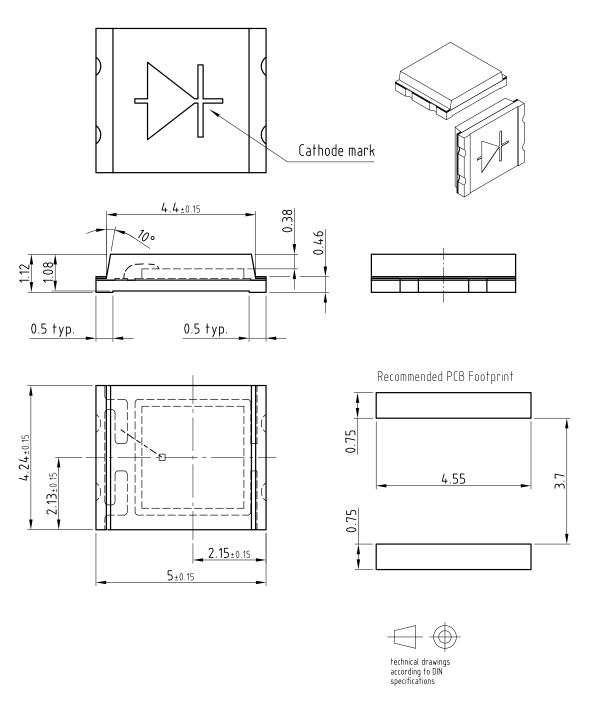


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters



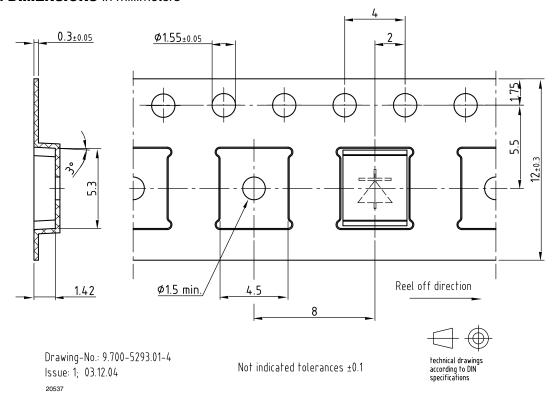
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Issue: 3; 05.02.08

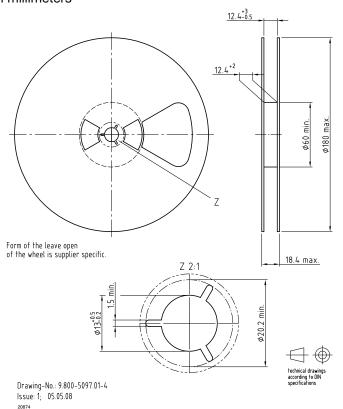
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Not indicated tolerances ± 0.1

TAPING DIMENSIONS in millimeters



REEL DIMENSIONS in millimeters



SOLDER PROFILE

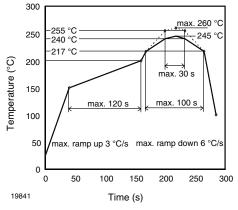


Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 4

Floor life: 72 h

Conditions: T_{amb} < 30 °C, RH < 60 %

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or recommended conditions:

192 h at 40 °C (+ 5 °C), RH < 5 %

or

96 h at 60 °C (+ 5 °C), RH < 5 %.



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Vishay

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